

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	WEI YAN	01/10/2017
RECEIVING PARTY DATA		
Name:	ZTE CORPORATION	
Street Address:	ZTE Plaza, Keji Road South	
Internal Address:	Hi-Tech Industrial Park, Nanshan District	
City:	Shenzhen City, Guangdong Province	
State/Country:	CHINA	
Postal Code:	518057	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15325089
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DATE SIGNED:	02/28/2017	
Total Attachments: 1		
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转让证明 **ASSIGNMENT**

代理人档案号(限 12 个字符内): Agent's file reference: (12 characters maximum)	US1700778
国际申请号: International application number:	PCT/CN2014/089096
国际申请日: International filing date:	2014-10-21
<p>鉴于壹圆人民币以及其他有益且充分的考虑, 本人特此将上述国际申请和在此国际申请中所公开的本发明创造, 以及要求此国际申请有关权利的任何接续申请或分案申请, 以及要求此国际申请优先权的任何外国申请的所有权益转让给</p> <p>In consideration of One Chinese RMB and other good and sufficient consideration, I hereby assign my interest in the above-identified international patent application and the invention disclosed therein, and any continuation or divisional application claiming the benefit therefrom, and any foreign patent application claiming priority therefrom,</p> <p>to <u>ZTE CORPORATION</u></p> <p>其位于</p> <p>having an address at <u>ZTE Plaza, Keji Road South, Hi-Tech Industrial Park, Nanshan, Shenzhen, Guangdong 518057 China .</u></p> <p>本人授权代理人在得知本案国际申请号及国际申请日后将其填入上方。</p> <p>I authorize the agent to insert the international application number and international filing date above when they are known.</p>	
发明人 I 签字 Inventor's signature	
发明人 I 全名 Printed inventor's Name	YAN, Wei
日期 Date signed	2017-1-10